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PCB Number: TIDA-00892 PCB Rev: A

PCB LOGO Pb-Free Symbol

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ZZ2 Assembly Note These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

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ZZ4 Assembly Note These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

	Orderable: ISOW7841RS485	Designed for: Public Relea	se	Mod. Date:	12/21/2016	_
	TID #: TIDA-00892	Project Title: TIDA-00892			TEXAS	
	Number: TIDA-00892 Rev: A	Sheet Title: Hardware She	et			INSTRUMENTS
	SVN Rev: Version control disabled	Assembly Variant: 001		She	et: 3 of 3	I (STICHILL (TS
	Drawn By:	File: TIDA-00892_Hardware.SchDoc Size: B		http://www.ti.com		
	Engineer: Anand Reghunathan	Contact: http://www.ti.com/support		© Texas Instruments 2015		
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licensors do not warrant that the desig	n is production worthy. You should completely va	alidate and test your desi	ign implementation to confirm the system functionali	ty for your application	n. Engi	1
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